

39th Annual Semiconductor Thermal Measurement, Modeling and Management Symposium
March 13-17, 2023 at the DoubleTree by Hilton, San Jose, CA USA

About SEMI-THERM

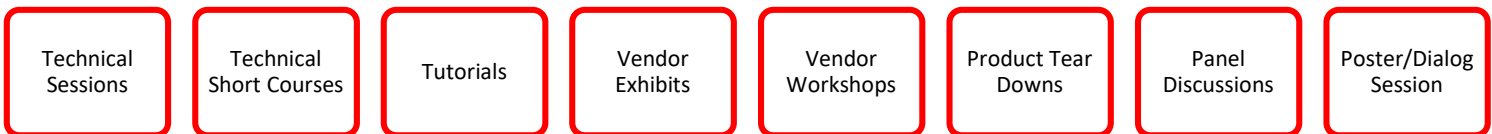
SEMI-THERM is an international symposium dedicated to the thermal management and characterization of electronic components and systems. Its goals are to:

- Provide knowledge covering all thermal length scales from integrated circuits to facility levels
- Foster discussions between thermal engineers, professionals and industry experts
- Encourage the exchange of information on academic and industrial advances in electronics cooling

Topics Include: Component/Board/System Thermal Design, Fluid Movers, Two-Phase Cooling, Acoustics, Advanced Materials, Measurement Methods, Modeling & Simulation, Additive Manufacturing, Reliability, etc.

Applications Include: Processors/ICs/Memory, 3-D packaging, Computing Systems, Data Centers, Portable/Consumer/Wearable Electronics, Power Electronics, Harsh Environments, Defense/Aerospace Systems, Automotive Systems; Solid-State Lighting & Cooling, Biomedical; Micro/Nano-scale Devices, etc.

Symposium Highlights



Four options for participating in the technical program:

Peer-reviewed paper: Submit a full manuscript for peer review. Authors notified of acceptance in November. Final manuscript due in January. Manuscripts will be provided to conference attendees.

Non-peer-reviewed paper: Submit an extended abstract (2-5 pages) that describes the scope, contents, key results, findings and conclusions. Authors notified of acceptance in November. Final manuscript due in January. Manuscripts will be provided to conference attendees.

Presentation only: Submit an extended abstract. Authors notified of acceptance in November. Final presentation slides are due in March. Presentations will be provided to conference attendees.

Poster: Submit an extended abstract to share your work with symposium participants at a dialog session during the symposium. Authors notified of acceptance in November. Poster authors may choose to submit a manuscript in January. Final poster due in March.

Awards: All papers with manuscripts, which will be available through IEEEExplore, are eligible for the Best Paper Award. Student papers presented at the conference are eligible for Student Scholarships. Presentation-only submissions are not eligible for awards.

Manuscripts and extended abstracts submission deadline	Date that authors are notified of acceptance	Photo-ready full manuscript submission due date
Sep 15, 2022	Nov 18, 2022	Jan 13, 2023

Upload your paper electronically in RTF, DOC or PDF formats at www.semi-therm.org.

For further information please contact the Program Chair

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Visit our website: <http://www.semi-therm.org>

**** All authors qualify for reduced symposium rates ****